

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3156776

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Masakazu Katayama	12/04/2014
Katsufumi Hiraishi	12/16/2014
Yoshiki Suto	12/16/2014
Natsuko Okazaki	12/17/2014
Hongyuan Wang	12/16/2014
RECEIVING PARTY DATA	
Name:	NIPPON STEEL & SUMIKIN CHEMICAL CO., LTD.
Street Address:	14-1, SOTOKANDA 4-CHOME
City:	CHIYODA-KU, TOKYO
State/Country:	JAPAN
Postal Code:	101-0021
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14409847
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NAME OF SUBMITTER:	LEE CHENG
SIGNATURE:	/Lee Cheng/
DATE SIGNED:	12/19/2014
Total Attachments: 1	
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CHENG LAW GROUP, PLLC
Docket No. _____

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert
ASSIGNEE's
Name(s)
Address(es)]

NIPPON STEEL & SUMIKIN CHEMICAL CO., LTD. of
14-1, Sotokanda 4-chome, Chiyoda-ku, Tokyo 101-0021 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE all of the right, title and interest to the invention entitled

[Title of
Invention]

DISPLAY DEVICE, METHOD FOR MANUFACTURING SAME,
POLYIMIDE FILM FOR DISPLAY DEVICE SUPPORTING BASES, AND
METHOD FOR PRODUCING POLYIMIDE FILM FOR DISPLAY DEVICE SUPPORTING BASES

[*If the assignment
is being filed
after the filing of the
application, this
section must be
completed]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

*filed on _____, Serial No. _____

(Cheng Law Group, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s)
of Assignor(s)]

<u>Masakazu KATAYAMA</u> (SIGNATURE)	Masakazu KATAYAMA (TYPE NAME)	<u>2014. 12. 4</u> (DATE)
<u>Katsufumi Hiraishi</u> (SIGNATURE)	Katsufumi HIRAISHI (TYPE NAME)	<u>2014. 12. 16</u> (DATE)
<u>Yoshiki SUTO</u> (SIGNATURE)	Yoshiki SUTO (TYPE NAME)	<u>2014. 12. 16</u> (DATE)
<u>Natsuko OKAZAKI</u> (SIGNATURE)	Natsuko OKAZAKI (TYPE NAME)	<u>2014. 12. 17</u> (DATE)
<u>Hongyuan Wang</u> (SIGNATURE)	Hongyuan WANG (TYPE NAME)	<u>2014. 12. 16</u> (DATE)
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_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)

PATENT